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April 2001

IGBT

SGS13N60UFD

Ultra-Fast IGBT

General Description

Fairchild's UFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UFD series is designed for applications such as motor control and general inverters where high speed switching is a required feature.

Features

- · High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.1 \text{ V } @ I_C = 6.5 \text{A}$
- · High input impedance
- CO-PAK, IGBT with FRD : t_{rr} = 37ns (typ.)

Application

AC & DC Motor controls, general purpose inverters, robotics, servo controls





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGS13N60UFD	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
_	Collector Current	@ T _C = 25°C	13	Α
I _C	Collector Current	@ T _C = 100°C	6.5	Α
I _{CM (1)}	Pulsed Collector Current		52	Α
I _F	Diode Continuous Forward Current	@ T _C = 100°C	8	Α
I _{FM}	Diode Maximum Forward Current		56	Α
P_{D}	Maximum Power Dissipation	@ T _C = 25°C	45	W
	Maximum Power Dissipation	@ T _C = 100°C	18	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes:(1) Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
R _{θJC} (IGBT)	Thermal Resistance, Junction-to-Case		2.7	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		1.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Cha	racteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 6.5 \text{mA}, V_{CE} = V_{GE}$	3.5	4.5	6.5	V
	Collector to Emitter	$I_C = 6.5A$, $V_{GE} = 15V$		2.1	2.6	V
V _{CE(sat)}	Saturation Voltage	I _C = 13A, V _{GE} = 15V		2.6		V
Dynami	c Characteristics					
C _{ies}	Input Capacitance			375		рF
C _{oes}	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$		63		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		13		pF
	ng Characteristics					
(d(on)	Turn-On Delay Time			20		ns
t _{d(on)} t _r	Turn-On Delay Time Rise Time	_		20 27		ns ns
t _r	-	V _{CC} = 300 V, I _C = 6.5A,				
t _r	Rise Time	$V_{CC} = 300 \text{ V}, I_{C} = 6.5\text{A},$ $R_{G} = 50\Omega, V_{GE} = 15\text{V},$		27		ns
t _r t _{d(off)} t _f	Rise Time Turn-Off Delay Time			27 70	130	ns ns
t_r $t_{d(off)}$ t_f E_{on}	Rise Time Turn-Off Delay Time Fall Time	$R_G = 50\Omega, V_{GE} = 15V,$		27 70 97	130 150	ns ns
t_r $t_{d(off)}$ t_f E_{on}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss	$R_G = 50\Omega, V_{GE} = 15V,$	 	27 70 97 85	130 150	ns ns ns
t_r $t_{d(off)}$ t_f E_{on} E_{ts}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss	$R_G = 50\Omega, V_{GE} = 15V,$	 	27 70 97 85 95	130 150 	ns ns ns μJ
t_r $t_{d(off)}$ t_f E_{on} E_{ts} $t_{d(on)}$	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss	$R_G = 50\Omega, V_{GE} = 15V,$	 	27 70 97 85 95 180	130 150 270	ns ns ns Lμ Lμ Lμ
t _r t _{d(off)} t _t E _{on} E _{off} E _{ts} t _{d(on)}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time	$R_G = 50\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25$ °C	 	27 70 97 85 95 180 30	130 150 270	ns ns ns μμ Lμ Lμ ns
t _r td(off) tf tf Eon Eoff Ets td(on) tr td(off)	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time	$R_G = 50\Omega, V_{GE} = 15V,$	 	27 70 97 85 95 180 30 32	 130 150 270 	ns ns ns Lu Lu Lu ns ns
t _r t _{d(off)} t _{d(off)} t _f E _{on} E _{off} Et _s t _{d(on)} t _r t _{d(off)}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time	$R_G = 50\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$ $V_{CC} = 300 \text{ V}$, $I_C = 6.5\text{A}$,	 	27 70 97 85 95 180 30 32 85	 130 150 270 200	ns ns ns Lμ Lμ Lμ ns ns
t _r t _{d(off)} t _f E _{on} E _{off} t _t t _{d(on)} t _r t _{d(off)}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$\begin{aligned} R_G &= 50\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 25^{\circ}C \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ V, \ I_C = 6.5A, \\ R_G &= 50\Omega, \ V_{GE} = 15V, \end{aligned}$	 	27 70 97 85 95 180 30 32 85 168	 130 150 270 200 250	ns ns ns Lu Lu Lu ns ns ns
t _r t _{d(off)} t _f E _{on} E _{off} t _{d(on)} t _t t _{d(off)}	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss	$\begin{aligned} R_G &= 50\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 25^{\circ}C \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ V, \ I_C = 6.5A, \\ R_G &= 50\Omega, \ V_{GE} = 15V, \end{aligned}$	 	27 70 97 85 95 180 30 32 85 168	 130 150 270 200 250	ns ns ns μ Lu Lu ns ns ns
t _r t _d (off) t _f E _{on} E _{off} t _d (on) t _r t _d (off) t _t t _d (off)	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- On Switching Loss Turn- Off Switching Loss	$R_{G}=50\Omega,\ V_{GE}=15V,$ Inductive Load, $T_{C}=25^{\circ}C$ $V_{CC}=300\ V,\ I_{C}=6.5A,$ $R_{G}=50\Omega,\ V_{GE}=15V,$ Inductive Load, $T_{C}=125^{\circ}C$	 	27 70 97 85 95 180 30 32 85 168 180	 130 150 270 200 250 	ns ns ns Lu Lu Lu sn sn sn ns ns
$\begin{array}{l} t_r \\ t_{d(off)} \\ t_f \\ E_{on} \\ E_{off} \\ E_{ts} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ E_{on} \\ E_{off} \\ E_{on} \\ E_{off} \\ E_{d(off)} \\ E_{on} \\ E_{off} \\ E_{d(off)} \\ E_{d(of$	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- Off Switching Loss Total Switching Loss	$R_{G} = 50\Omega, \ V_{GE} = 15V,$ Inductive Load, $T_{C} = 25^{\circ}C$ $V_{CC} = 300 \ V, \ I_{C} = 6.5A,$ $R_{G} = 50\Omega, \ V_{GE} = 15V,$ Inductive Load, $T_{C} = 125^{\circ}C$ $V_{CE} = 300 \ V, \ I_{C} = 6.5A,$	 	27 70 97 85 95 180 30 32 85 168 180 165 345	 130 150 270 200 250 500	ns ns ns ns Lu Lu sn sn sn Lu Lu Lu
	Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- Off Switching Loss Total Switching Loss Total Gate Charge	$R_{G}=50\Omega,\ V_{GE}=15V,$ Inductive Load, $T_{C}=25^{\circ}C$ $V_{CC}=300\ V,\ I_{C}=6.5A,$ $R_{G}=50\Omega,\ V_{GE}=15V,$ Inductive Load, $T_{C}=125^{\circ}C$	 	27 70 97 85 95 180 30 32 85 168 180 165 345 25	 130 150 270 200 250 500 35	ns ns ns ns us us us us us ns us us us nc

Electrical Characteristics of DIODE $T_{C} = 25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Units
V	Diode Forward Voltage	I _F = 8A	$T_C = 25^{\circ}C$		1.4	1.7	V
V_{FM}	blode Forward Voltage	IF = OA	T _C = 100°C		1.3]
+	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$		37	55	ne
t _{rr}	Diode Reverse Recovery Time		T _C = 100°C		55		ns
1	Diode Peak Reverse Recovery	I _F = 8A,	$T_C = 25^{\circ}C$		3.5	5.0	Α
^I rr	Current	$di/dt = 200A/\mu s$	T _C = 100°C		4.5		_ A
0	Q _{rr} Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		65	138	nC
Q _{rr}			T _C = 100°C	-	124		IIC

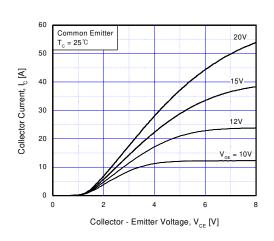


Fig 1. Typical Output Chacracteristics

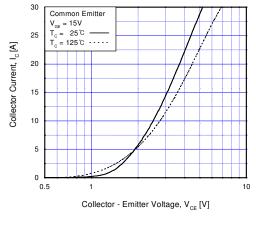


Fig 2. Typical Saturation Voltage Characteristics

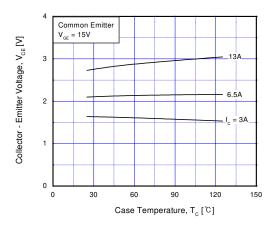


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

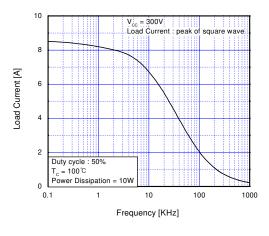


Fig 4. Load Current vs. Frequency

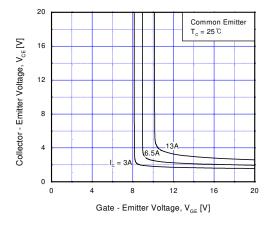


Fig 5. Saturation Voltage vs. V_{GE}

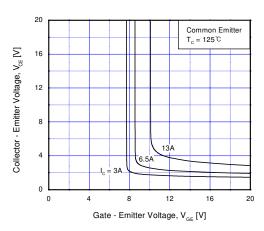
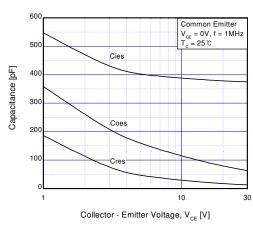


Fig 6. Saturation Voltage vs. $V_{\rm GE}$

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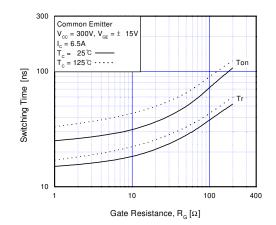
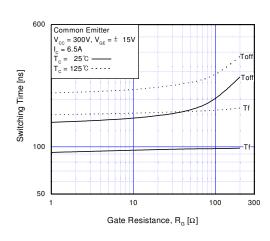


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



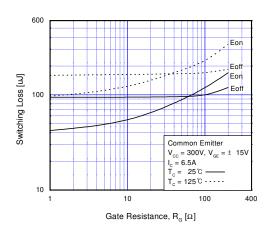
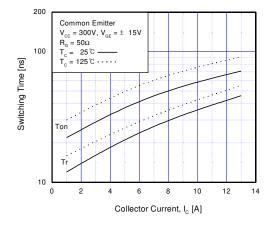


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



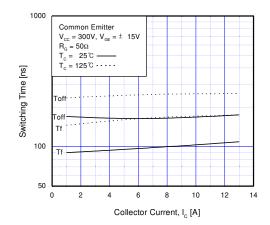
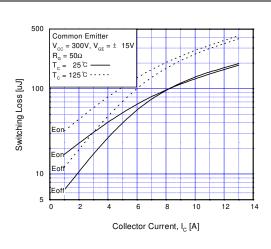


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current



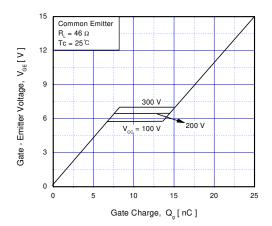
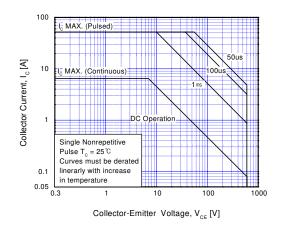


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



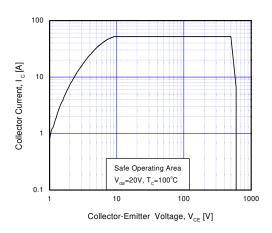


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

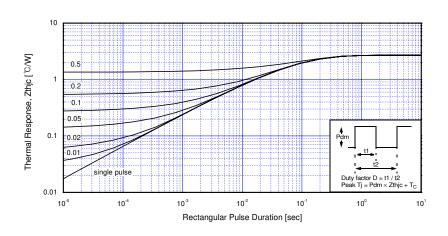
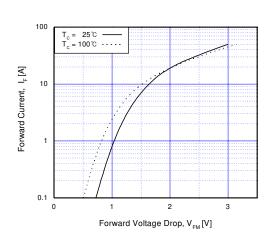


Fig 17. Transient Thermal Impedance of IGBT



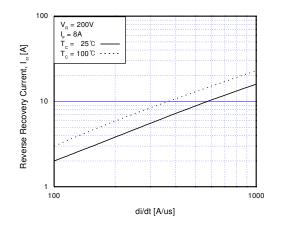
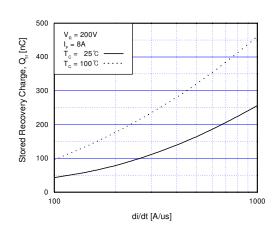


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current



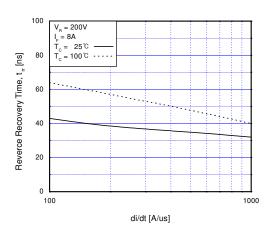
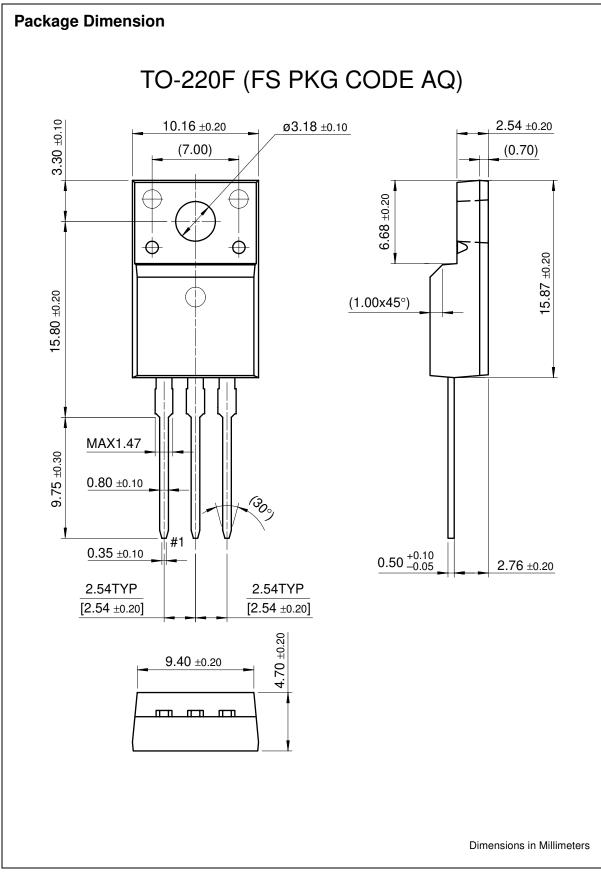


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time



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